ATTY DOCKET NO. Form PTO 1449 SERIAL NO. U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE 211810US99 09/911,495 (Modified) 011 8 **APPLICANT** LIST OF REFERENCES CITED BY APPLICANT BARBARA F. BARENBURG ET AL **GROUP** FILING DATE FEB 0 6 2002 2813 JULY 25, 2001 **U.S. PATENT DOCUMENTS** DOCUMENTADEN SUB FILING DATE **EXAMINER CLASS** DATE NAME IF APPROPRIATE **CLASS** INITIAL NUMBER 5B6 AA4,174,422 11/13/79 Matthews et al. 500 06/11/85 Morimoto et al. AB 4,523,211 506 AC 4,661,176 04/28/87 Manasevit AD 4,793,872 12/27/88 Meunier et al. ろいし 506 ΑE 08/08/89 Akasaki et al. 4,855,249 ΑF 03/27/90 5130 4,912,087 Aslam et al. 5 BG 5,173,474 12/22/92 Connell et al. AG AΗ 10/25/94 Neville Connell et al. 566 5 358 925 02/28/95 Summerfelt 500 ΑI 5,393,352 506 ΑJ 5,418,216 05/23/95 566 ΑK 5,450,812 09/19/95 McKee et al. AL 5,478,653 12/26/95 Guenzer *55*5 McKee et al. AM 5,482,003 01/09/96 30C ΑN 05/07/96 Nashimoto 53U 5,514,484 ΑO 5,588,995 12/31/96 Sheldon 5 BG ΑP Fork et al. ٤٤٢ 5,733,641 03/31/98 11/03/98 McKee et al. 5*B*G AQ 5,830,270 500 AR 5,912,068 06/15/99 Jia 530 02/01/00 Wollesen AS 6.020.222 05/16/00 356 AT 6,064,092 Park 586 ΑU 6,096,584 08/01/00 Ellis-Monaghan et al. SOL ΑV 10/24/00 6,136,666 So ΑW 01/16/01 506 6.174.755 Manning AX 6,180,486 01/30/01 Leobandung et al. 536 536 ΑY 3,802,967 04/09/74 Ladany et al. 3 CG ΑZ 4,404,265 09/13/83 Manasevit 3BG ВА 4,482,906 11/13/84 Hovel et al. 500 BB 4,846,926 07/11/89 Kay et al. 01/02/90 Shastry 536 BC 4,891,091 586 BD 05/22/90 4,928,154 Umeno et al ΒE 4,963,949 10/16/90 Wanlass et al. 586 386 5,141,894 08/25/92 Bisaro et al. BF 526 Calviello et al 10/27/92 BG 5,159,413 30 G BH 5,221,367 06/22/93 Chisholm et al. 536 ВΙ 5,225,031 07/06/93 McKee et al. 1BG BJ 5,556,463 09/17/96 Guenzer 5,670,798 09/23/97 Schetzina SGU BK 5236 BL 5,735,949 04/07/98 Mantl et al 586 ВМ 5,741,724 04/21/98 Ramdani et al. BN Yano et al. 536 5,810,923 09/22/98 BO 5 B 6 6,045,626 04/04/00 Yano et al. ΒP 6,064,078 05/16/00 Northrup et al. 5BG 6,103,008 08/15/00 McKee et al.

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5/36	CA	6,107,653	08/22/00	Fitzgerald			
535	СВ	6,113,690	09/05/00	Yu et al.			
500	СС	6,143,072	11/07/00	McKee et al.			
586	CD	5,155,658	10/13/92	Inam et al.			
5BC-	CE	5,248,564	09/28/93	Ramesh			
30G	CF	5,270,298	12/14/93	Ramesh			
5 BG	CG	5,418,389	05/23/95	Watanabe			
386	СН	6,055,179	04/25/00	Koganei et al.			
336	CI	5,326,721	07/05/94	Summerfelt			
5B6	CJ	5,310,707	05/10/94	Oishi et al.		-	
506	СК	4,999,842	03/12/91	Huang et al.			
536	CL	5,874,860	02/23/99	Brunel et al.			/ //
506	СМ	6,002,375	12/14/99	Corman et al.			
536	CN	4,802,182	01/31/89	Thornton et al.			
5B (-	со	4,284,329	08/18/81	Smith et al.			
51 G	СР	4,006,989	02/08/77	Andringa			·
536	cq	5,729,641	03/17/98	Chandonnet et al.			
SBF	CR	5,640,267	06/17/97	May et al.			
586	cs	5,576,879	11/19/96	Nashimoto			
3 BG	СТ	5,528,414	06/18/96	Oakley	—		
3 G tr	CU	4,802,182	01/31/89	Thornton et al.			
286	CV	5,436,759	07/25/95	Dijaii et al.	—	-	
336	cw	6,128,178	10/03/00				
386		6,121,642	09/19/00	Newns	_		
336	CY	5,926,496		Ho et al.			· · · · · · · · · · · · · · · · · · ·
5 B (s	CZ	5,790,583	08/04/98	Но			<u> </u>
536	DA	5,825,799	10/20/98	Ho et al.	_		
386	DB	5,857,049	-	Beranek et al.		_	.,
3 BG	DC	6,184,144B1	02/06/01		.,		
300	DD	5,981,400	11/09/99	Lo	—		
50G	DE	5,286,985	02/15/94	- · · · · · · · · · · · · · · · · · · ·			
300	DF	3,766,370	10/16/73		_		
500	DG	4,777,613	10/11/98	Shahan et al.			
3BU	DH	5,990,495	11/23/99		T —		
536-	DI	5,081,062		Vasudev et al.	 		
53 G	DJ	5,404,581	04/04/95	 			
5B6	DK	4,896,194	01/23/90				,_,
30st	DL	5,606,184	-	Abrokwah, et al.	_		
5 BG	DM	5,060,031		Abrokwah, et al.		<u> </u>	
5 B G	DN	6,114,996	09/05/00	·			
586	DO	4,882,300		Inoue et al.			
38G	DP	5,674,366		Hayashi et al.		<u> </u>	·
596	DQ	6,173,474	01/16/01				
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336	EB	5,828,080	10/27/98	Yano et al.			
506	EC	5,801,105	09/01/98	Yano et al.			
586	ED	4,484,332	11/20/84	Hawrylo			
5136	EE	4,815,084	03/21/89	Scifres et al.			
506	EF	5,293,050	03/08/94	Chapple-Sokol et al			
5 B G	EG	6,222,654	04/24/01	Frigo			
386	EH	5,937,285	08/10/99	Abrokwah et al.			
336	EI	5,116,461	05/26/92	Lebby et al.			
555	EJ	5,640,267			<u> </u>		
500	EK	5,442,191	08/15/95	·		<u> </u>	<u></u>
5 B G	EL	6,008,762	12/28/99				
5 B G	EM	5,444,016		Abrokwah, et al.	 		<u></u>
286	EN	5,614,739	03/25/97	Abrokwah et al.			
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386 386	EP	5,144,409	09/01/92				
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536	ER	5,995,359		Klee et al.			
5 B (ES	6,146,906	11/14/00				
5 B G	ET	6,180,252 B1	01/30/01	Farrell et al.			
336	EV	4,876,219		Eshita et al.			
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5B&	EX	4,963,508		Umeno et al.			
506-	 	5,063,166		Mooney et al.			
5 BC		5,356,831		Calviello et al.			
366	FA	5,777,762		Yamamoto			
53U	FB	5,778,116	07/07/98	*** **********	-		
5B6	FC	5,127,067	ļ	Delcoco et al.			
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830	FE	6,137,603	10/24/00				
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555	FH	5,764,676	06/09/98	Paoli et al.			
5 B(6	FI	5,729,394	03/17/98	Sevier et al.			
30.0	FJ	5,883,996	03/16/99	Knapp et al.			
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300	AAJ	10-321943	12/04/98	Japan		
536	AAK	11-238683	08/31/99	Japan	X	•
536	AAL	11-260835	09/24/99	Japan w/English Abstract	x	
	-	HEI 2-391		Japan w/English Abstract	X	
200 200	-	5-48072	02/26/93	Japan w/English Abstract	X	
356		52-88354	07/23/77	Japan	X	
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505	⊢—	55-87424	07/02/80	Japan	х	
506		61-108187	05/26/86	Japan w/English Abstract	X	
56G	-	6-232126	08/19/94	Japan	X	
556		6-291299		Japan w/English Abstract	X	
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5BG	├	63-131104		Japan w/English Abstract	X	
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366	AAZ	WO 99/63580	12/09/99	WIPO	Х	
350	BAA	WO 99/14804	03/25/99	WIPO	X	-
300	BBB	WO 97/45827	12/04/97	WIPO		
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5BC	BBD	WO 00/33363	06/08/00	WIPO		
536	BBE	WO 00/48239	08/17/00	WIPO		
3 OC	BBF	WO 99/14797	03/25/99	WIPO		
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